

IN THE SPECIFICATION

Please amend the paragraph starting on page 11, line 9 as follows:

P¹ For clarity, electrical leads and contacts, formed from Cu, Au, or other metals or metallic alloys in a conventional manner are not illustrated in FIG. 6. Other materials that make only a small volume fraction of the head can also be present. For example, very thin films, such as a bonding film 642, of intermediate materials can be deposited to improve bonds between layers of dissimilar materials.
